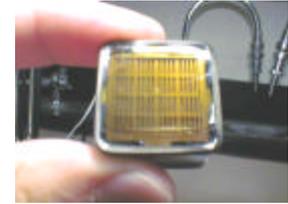
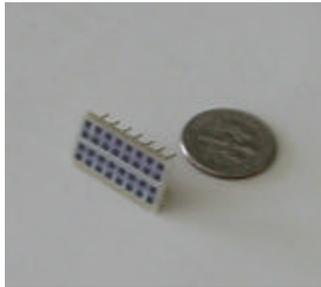

Photodetectors



*Readout options for a very large
scintillator detector*

Roger Rusack



Presented by Ken Heller

Statement of the Problem

- ◆ *Readout two fibers in a single channel.*
- ◆ *Signal from a muon is 25 photons at 510 nm at 8 m in MINOS scintillator.*
- ◆ *Number of channels:*
 - 500,000 Longer scintillator strips 1/3 X_0 sampling.
 - 2,000,000 Shorter Scintillator in containers.
- ◆ *Beam-spill interval 10 microsecond.*
- ◆ *Repetition rate ~2 sec.*
- ◆ *Cost must be as low.*
- ◆ *Maintenance and operation simple (ie cheap).*

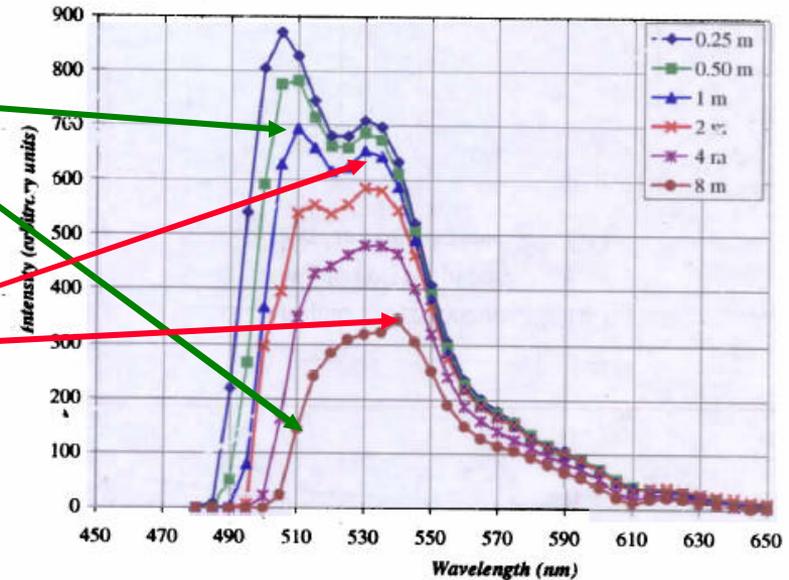


Spectrum

Attenuation 1m to 8m:

At 510 nm signal drops by 5

At 540 nm signal drops by 2



PMT's prefer it blue.

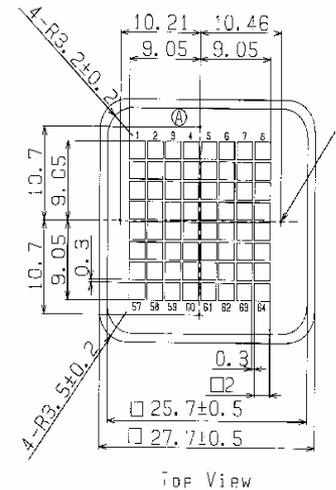
For L large, the attenuation length of light at 500 nm is 10m – determined by the plastic in the fiber not the internal reflections.

This is measured with a PMT.

What's new and what's not new.

◆ *Multi-Channel PMT's.*

- Hamamatsu still are manufacturing M-64's.
 - » QE ~ 10% at 510 nm.
 - » Gain 10^5 - 10^6 .
 - » Well known to MINOS collaborators.
 - » Cost could be less than they were for MINOS if are relaxed.



◆ *Flat Panel PMT's*

- As advertised on the back of the CERN Courier.
- Are very nice
- And very expensive.

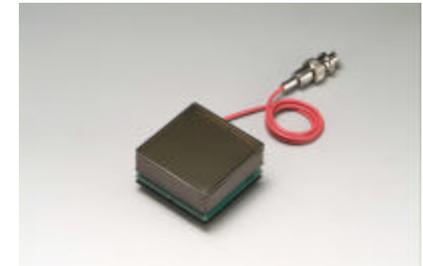
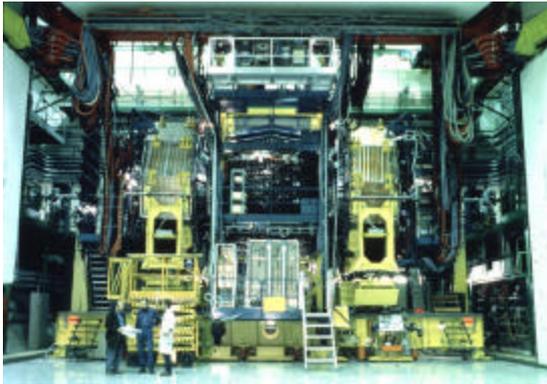
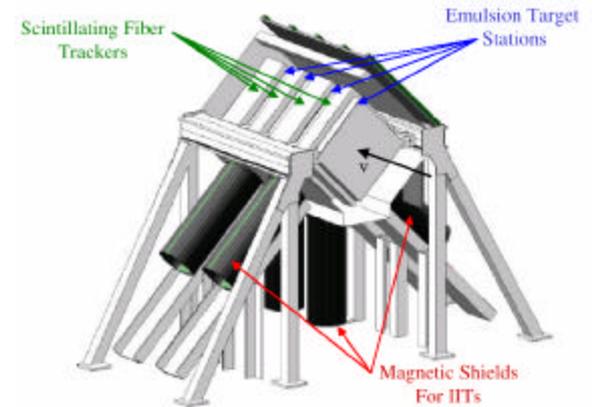


Image Intensifiers

*Have been used in
UA2 to readout 80,000 1mm fibers.*



*DONUT (E872) to readout
500,000 fibers.*



CHORUS to readout 1,000,000 fibers.



K2K to readout 275,000 fibers.



Image Intensifiers

- ◆ *Well understood technology.*
- ◆ *Individual II chains are expensive (~\$10,000).*
- ◆ *Readout ~ 6,000 0.5 mm fibers per II chain.*
- ◆ *Electronics is cheap: CCD + electronics (~\$2,000).*
- ◆ *Costs ~ \$4.00/doubled fiber.*
- ◆ *Triggerable with 1 microsecond gate.*
- ◆ *10% QE*

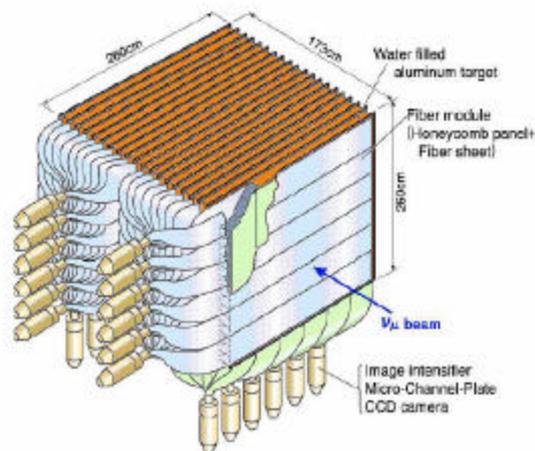


Fig. 2. A schematic view of the K2K scintillating fiber detector. The detector has the dimension of 260cm x 260cm x 173cm in (x, y, z). The central fiducial mass region is defined to be 220cm x 220cm x 130cm in (x, y, z).

From K2K

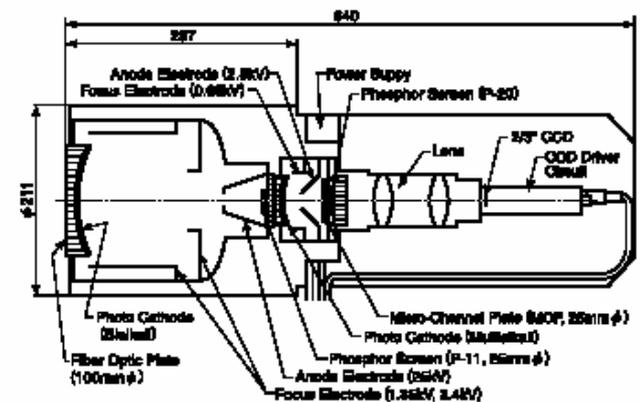


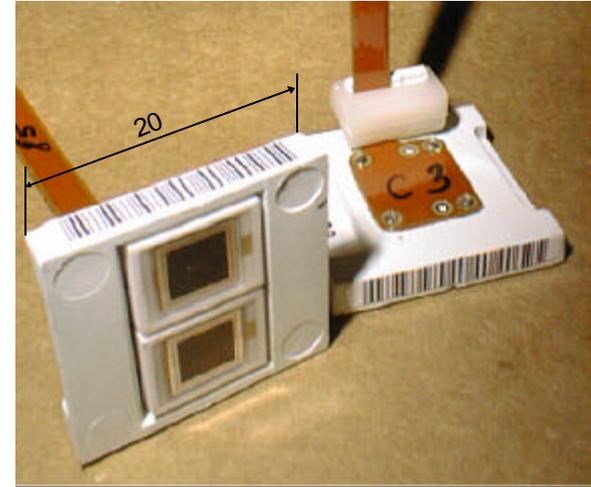
Fig. 2. IIT-CCD chain.

Avalanche Photodiodes.

- ◆ *APD's have been around since 1968.*
- ◆ *Different types:*
 - Perkin-Elmer (formerly EG&G and RCA) reverse APD
 - API/RMD Neutron Transformation Doped (NTD) devices.
 - Hamamatsu epitaxial growth APD's.
- ◆ *Status:*
 - » API and RMD
 - ◆ Small companies without major manufacturing background
 - ◆ They die through thermal run away in radiation environments –not popular.
 - » Perkin Elmer
 - ◆ Hard to manufacture, which makes them expensive.
 - » Hamamatsu
 - ◆ Uses standard industry techniques in manufacture.
 - ◆ LHC expt. CMS is using 126,000 5 mm x 5 mm APD's.

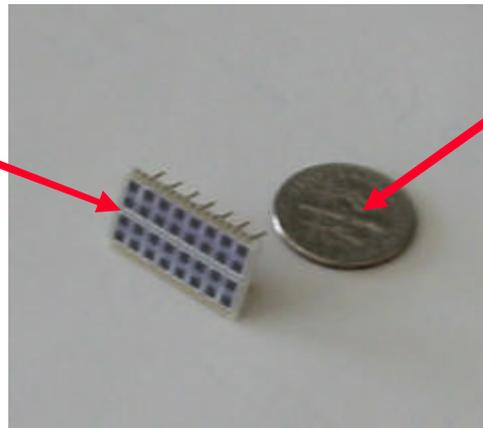
Hamamatsu APD's

- ◆ *CMS crystal readout:*
 - $5 \times 5 \text{ mm}^2$.
- ◆ *86,000 delivered.*
- ◆ *Delivery rate 7000/month.*
- ◆ *Cost 42.5 CHF (~\$30) each.*



Hamamatsu have developed an $1.6 \times 1.6 \text{ mm}^2$ array based on the same junction structure developed for CMS.

**Two 16-channel
arrays**

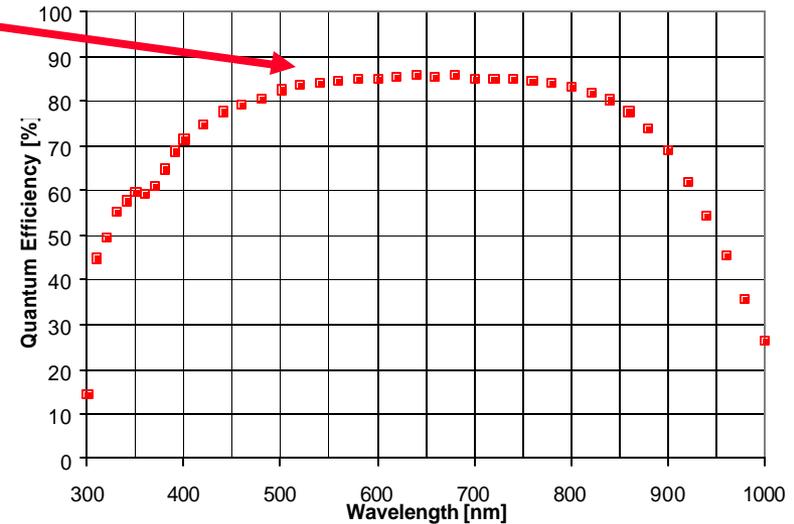


A dime (10¢)

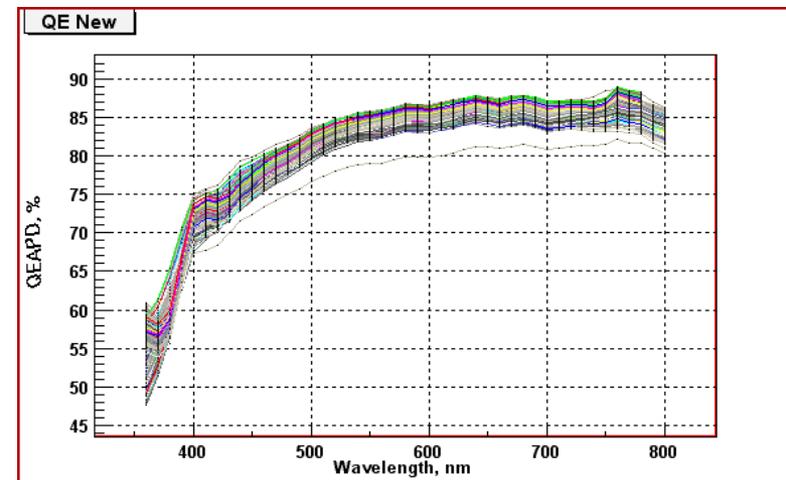
*Operating characteristics are
the same as the CMS APD.*

Characteristics.

- ◆ *QE sits is around 85%
at spectral peak:*



and is repeatable.



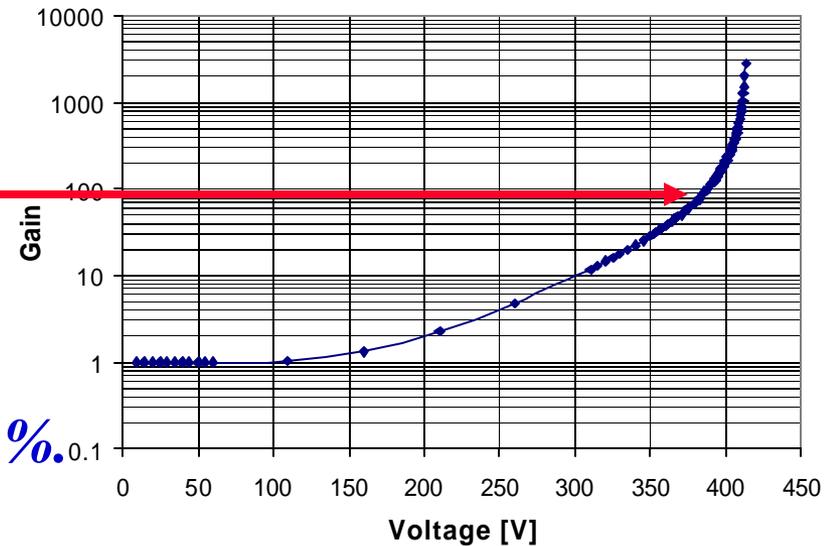
Gain

- ◆ *Can run at gains up to 200 with reasonable headroom (10V).*

$$V_{\text{operating}} - V_{\text{breakdown}} \sim 30 \text{ V}$$

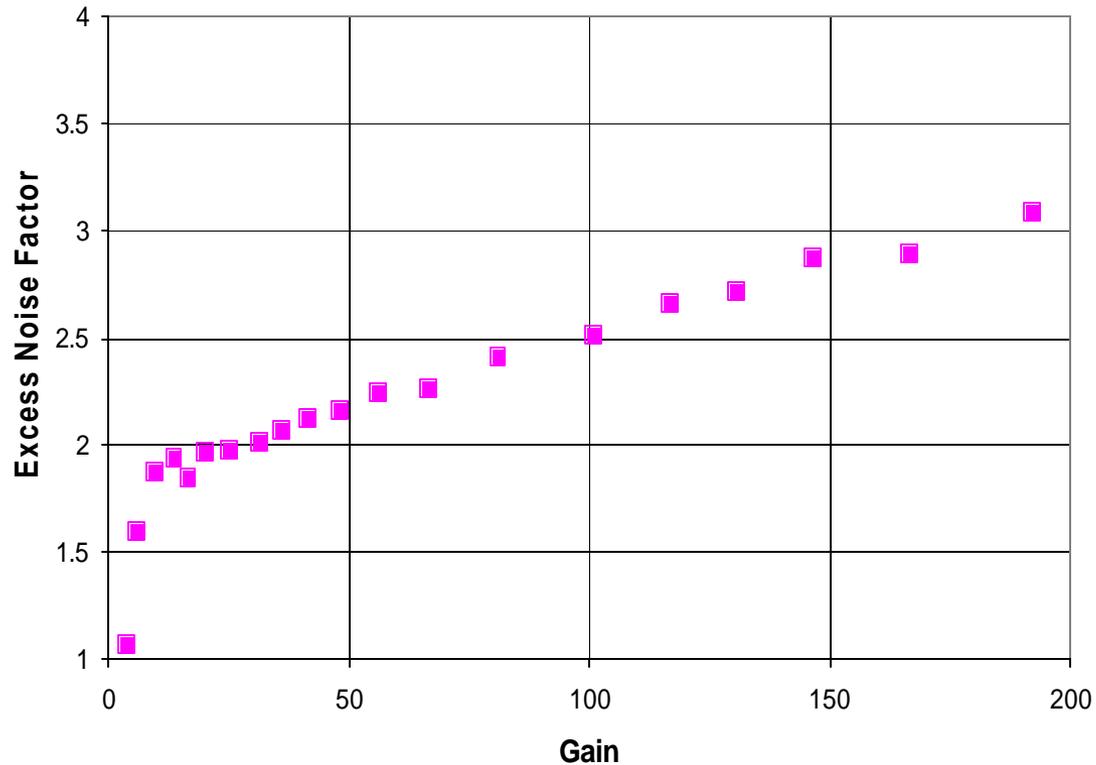
- ◆ *We assume a gain of 100.*

- ◆ *Pixel-to-pixel uniformity is $\pm 3\%$.*



Excess Noise Factor

- ◆ *Excess noise Factor increases with gain.*



This means that device gets noisy at high gain.

Costs

- ◆ *Pixel size is 1.6 x 1.6 mm².*
- ◆ *Use bare die (Protected with Si₃N₄ coating – not epoxy) just like the silicon trackers.*
- ◆ *Price in quantities of 500,000 channels - \$2.65 - \$2.75 ea.*
- ◆ *Price in quantities of 1,500,000 channels - \$2.00 - \$2.10 ea.*

Variations in price is determined by value of the yen and what specs we require.

Application

- ◆ *Low Gain:*
- ◆ *Mean muon signal after amplification is $35 * 0.85 * 100 = 3000$ electrons.*
- ◆ *Use double correlation technique to detect signal used in one Fermilab chip (MASDA) which has a level of 300 electrons with 250 nsec integration.*
- ◆ *Most significant source of noise is the Schott noise from thermally generated electrons upstream of the junction*

Schott Noise

- ◆ *Thermal current generated before the junction is multiplied and is indistinguishable from the signal.*
- ◆ *It obeys Arrhenius relation and decreases exponentially with T – at room temp a factor 2 every 7 C.*
- ◆ *At 28°C current corresponds to 60 electrons generated in 100 nsec. This reduces to four at –7C.*
- ◆ *Design for an operating temperature of –10°C (18°F).*

Readout

- ◆ *Joint Fermilab-Minnesota effort to test this idea.*
 - Use an existing 128 channel chip MASDA,
 - Pre- and post- sampling integrator designed for amorphous silicon imaging.
 - Johnson noise levels 300 electrons in 250 nsec with 10 pF – this decreases as integration time increases.

Cost Estimate.

◆ *Assumptions:*

- **64-channel fibers-APD modules.**
- **Cooling with a single stage Thermal Electric cooler. (Peltier).**
- **Cool only APD (0.2 mW) to – 10C. *Not electronics.***
- **HV (400 V) supplied by a single Cockroft-Walton supply (being designed at Fermilab). 1/module.**

◆ *Readout concept.*

- **64-channel ASIC Charge in/Bits out.**
- **Continuous charge integration.**
- **Divide spill into 100 nsec intervals.**
- **Store integrator output values on capacitors**
 - » **One capacitor for each interval. (Like SVX4).**
 - » **Convert charge on caps with one on-chip 10-bit ADC.**
- **Control Logic (FPGA)**
 - » **Generates trigger bit.**
 - » **Sends all data after trigger accept to event concentrator (1024 -channels).**
 - » **Resets ASIC.**
- **Send data to DAQ on commercial fiber optic link 1/1024 channels.**

Cost Estimate

System costs were estimated by Ray Yarema all costs are fully burdened and include engineering, prototyping, fabrication and testing for 1,000,000 yielded channels.

◆ *Cockroft-Walton*

- **Chip cost \$8.70**
 - » **Chip area 12 mm², 10 wafers + masks -- \$50k (\$55k for masks).**
 - » **Testing -- \$136,000.**
- **Other on board components. \$7.00**
- **Cost per 64 channels \$15.70 (\$0.25/channel.).**

◆ *APD readout chip.*

- **Chip cost \$33.79.**
 - » **48 mm² size – total area 750,000 mm², 40 wafers (\$200k).**
 - » **Testing - 50¢/die.**
- **Cost per 64 channels \$33.79 (\$0.53/channel.).**

Cost Estimate

◆ *Board costs:*

- **Circuit board cost = \$3.00 (15,000 4-layer 2" x 4" boards)**
- **TE cooler = \$5.00 (Just the junction - Catalog)**
- **Thermocouples = \$2.00**
- **Small FPGA (400 NAND gates) = \$5.00**
- **Four 16 channel APDs = 64 x \$2.50 = \$160**
- **C-W chip and support parts = \$15.70**
- **APD readout chip = \$33.79**
- **Other parts = \$2.00**
- **Board Assembly = \$5.00**
- **Production board tester = \$2.00 (?)**
- **Board test and repair = \$5.00 (?)**

◆ ***Total estimated readout cost \$3.73 /channel including APD.***

◆ ***Add 25% contingency.***

Cost per channel including the APD and 25% contingency= \$4.65.

Comparison

IIT

- **Advantage**
 - **Cost: \$4/ Channel**
 - **Experience (DONUT, Chorus, K2K)**
- **Disadvantage**
 - **Hundreds of modules/ IIT**
 - **Complexity Cost**
 - **Fiber Cost**
 - **12% QE**

M64

- **Advantage**
 - **Experience (MINOS)**
 - **Match to module size**
- **Disadvantage**
 - **Cost: \$14/ Channel**
 - **12% QE**

APD

- **Advantage**
 - **Experience (CMS)**
 - **Cost: \$4/ Channel**
 - **Match to module size**
 - **85% QE**
- **Disadvantage**
 - **Unfamiliar to many**

Continuing Work

- **Investigate signal-to-noise with long fibers readout with a Hamamatsu APD array in a parameter space of**
 - » **Temperature.**
 - » **Integration time.**
 - » **APD gain.**